

Through Hole Lamp Product Data Sheet LTL1KHKFD-0G1A

Spec No.: DS20-2009-0002 Effective Date: 02/06/2009 Revision: -



BNS-OD-FC001/A4

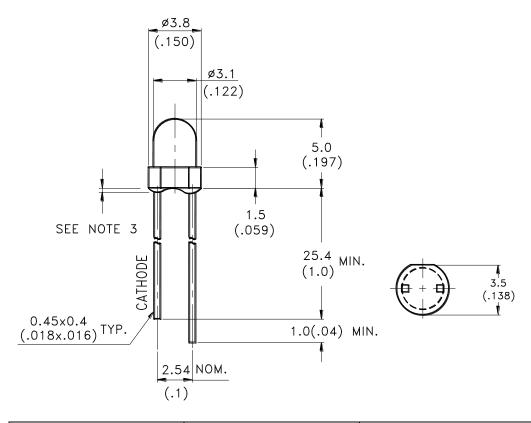
LITE-ON Technology Corp. / Optoelectronics No.90,Chien 1 Road, Chung Ho, New Taipei City 23585, Taiwan, R.O.C. Tel: 886-2-2222-6181 Fax: 886-2-2221-1948 / 886-2-2221-0660 http://www.liteon.com/opto

Property of Lite-On Only

Features

- * Lead (Pb) free product RoHS compliant.
- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * 3.1 mm diameter package.

Package Dimensions



Part No.	Lens	Source Color
LTL1KHKFD-0G1A	Orange Diffused	AlInGaP Yellow Orange

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm (.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.
- 6. The LED lamp use LTL1KHKFD

Part No. : LTL1KHKFD-0G1A

Page : 1 of 11



Property of Lite-On Only

Absolute Maximum Ratings at TA=25°C		
Parameter	Maximum Rating	Unit
Power Dissipation	75	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
DC Forward Current	30	mA
Derating Linear From 50°C	0.4	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-40°C to + 100°C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [2.0mm(.078") From Body]	260°C for 5 Seconds Max.	

Part No. : LTL1KHKFD-0G1A	



Property of Lite-On Only

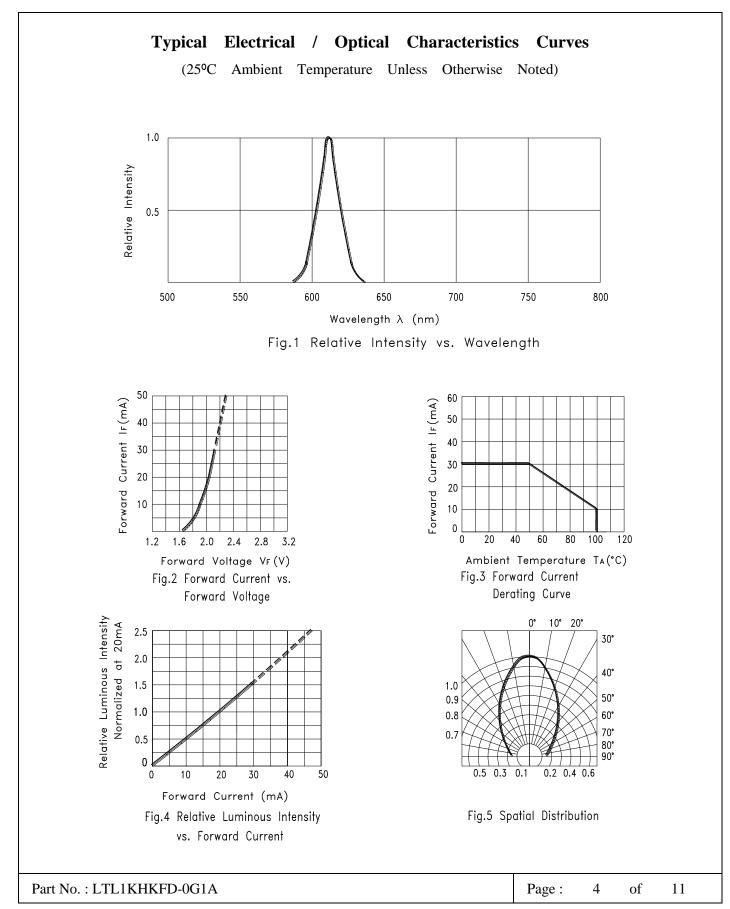
Electrical / Optical Cha	racteristics	at TA=25	5⁰C			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	85	140	400	mcd	I _F = 20mA Note 1
Viewing Angle	2 0 1/2		75		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λρ		611		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ_d	598	605	613.5	nm	Note 4
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	VF	1.5	2.05	2.4	v	$I_F = 20 m A$
Reverse Current	IR			100	μΑ	$V_R = 5V$
Capacitance	C		40		pF	$V_F = 0 \ , \ f = 1 M H z$

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



Property of Lite-On Only



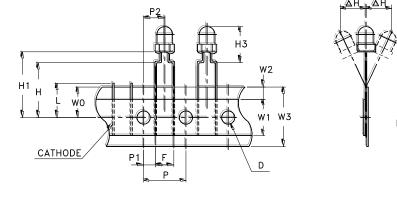
BNS-OD-C131/A4

Property of Lite-On Only

Features

- * Compatible with radial lead automatic insertion equipment.
- * Most radial lead plastic lead lamps available packaged in tape and folding.
- * 5mm (0.197") formed lead spacing available.
- * Folding packaging simplifies handling and testing.
- * Reel packaging is available by removing suffix "A" on option.

Package Dimensions

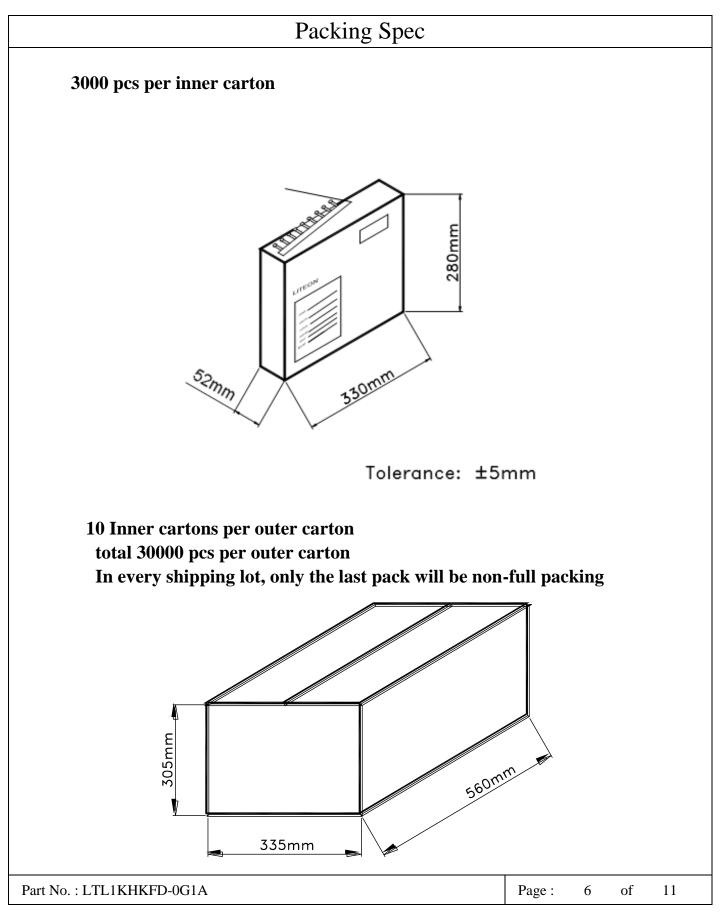


TAPE FEED DIRECTION

		Specification				
Item	Symbol	Minimum		Maximum		
		mm	inch	mm	inch	
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165	
Component Lead Pitch	F	4.8	0.188	5.8	0.228	
Front to Rear Deflection	ΔH			2.0	0.078	
Height of Seating Plane	Н	15.5	0.610	16.5	0.649	
Feed Hole to Bottom of Component	H1	20.0	0.787	22.0	0.866	
Seating Plane to Top of Component	Н3	9.5	0.374	10.5	0.413	
Lead Length After Component Height	L	W	VO	11.0	0.433	
Feed Hole Pitch	Р	12.4	0.488	13.0	0.511	
Lead Location	P1	3.15	0.124	4.55	0.179	
Center of Component Location	P2	5.05	0.198	7.65	0.301	
Total Taped Thickness	Т			0.90	0.035	
Feed Hole Location	W0	8.5	0.334	9.75	0.384	
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610	
Adhesive Tape Position	W2	0	0	3.0	0.118	
Tape Width	W3	17.5	0.689	19.0	0.748	
rt No. : LTL1KHKFD-0G1A		Pa	ge : 5	of of	11	



Property of Lite-On Only



BNS-OD-C131/A4



Property of Lite-On Only

Bin Table Specification

Luminous Inte	nsity Unit : mcd @20mA		
Bin Code	Min.	Max.	
EF	85	140	
GH	140	240	
JK	240	400	

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength		nit : nm @20mA
Bin Code	Min.	Max.
H22	598.0	600.0
H23	600.0	603.0
H24	603.0	606.5
H25	606.5	610.0
H26	610.0	613.5

Note: Tolerance of each bin limit is ± 1 nm

Part No. : LTL1KHKFD-0G1A

Property of Lite-On Only

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3 mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, For Lamp without stopper type and must be leave a minimum of 3 mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions :

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

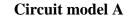
Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

of 11 Page : 8

Property of Lite-On Only

6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



Circuit model B

11



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No. : LTL1KHKFD-0G1A	Page :	9	of
---------------------------	--------	---	----

Property of Lite-On Only

Suggested checking list :

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No. : LTL1KHKFD-0G1A	Page :	10	of	11
---------------------------	--------	----	----	----



Property of Lite-On Only

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	Ta= 65 ± 5 °C RH= 90 ~ 95% Test Time= 240HRS \pm 2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	$\begin{array}{rrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrr$	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
	Thermal Shock	$\begin{array}{rrr} 105 \pm 5 {}^{\circ}\!\mathrm{C} &\sim & -55 {}^{\circ}\!\mathrm{C} \pm 5 {}^{\circ}\!\mathrm{C} \\ 10 \mathrm{mins} & & 10 \mathrm{mins} \\ 10 \mathrm{Cycles} \end{array}$	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	T.sol = 260 °C Max Dwell Time= 5secs Max	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability	T. sol = $230 \pm 5^{\circ}$ C Dwell Time= 5 ± 1 secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No. : LTL1KHKFD-0G1A

Page : 11 of 11